

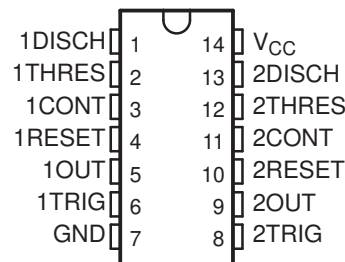
## FEATURES

- Two Precision Timing Circuits Per Package
- Astable or Monostable Operation
- TTL-Compatible Output Can Sink or Source up to 150 mA
- Active Pullup or Pulldown
- Designed to Be Interchangeable With Signetics NE556, SA556, and SE556

## APPLICATIONS

- Precision Timers From Microseconds to Hours
- Pulse-Shaping Circuits
- Missing-Pulse Detectors
- Tone-Burst Generators
- Pulse-Width Modulators
- Pulse-Position Modulators
- Sequential Timers
- Pulse Generators
- Frequency Dividers
- Application Timers
- Industrial Controls
- Touch-Tone Encoders

NA556...D OR N PACKAGE  
NE556...D, N, OR NS PACKAGE  
SA556...D OR N PACKAGE  
SE556...J PACKAGE  
(TOP VIEW)



## DESCRIPTION/ORDERING INFORMATION

These devices provide two independent timing circuits of the NA555, NE555, SA555, or SE555 type in each package. These circuits can be operated in the astable or the monostable mode with external resistor-capacitor (RC) timing control. The basic timing provided by the RC time constant can be controlled actively by modulating the bias of the control-voltage input.

The threshold (THRES) and trigger (TRIG) levels normally are two-thirds and one-third, respectively, of V<sub>CC</sub>. These levels can be altered by using the control voltage (CONT) terminal. When the trigger input falls below trigger level, the flip-flop is set and the output goes high. If the trigger input is above the trigger level and the threshold input is above the threshold level, the flip-flop is reset, and the output is low. The reset (RESET) input can override all other inputs and can be used to initiate a new timing cycle. When RESET goes low, the flip-flop is reset and the output goes low. When the output is low, a low-impedance path is provided between the discharge (DISCH) terminal and ground (GND).



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### ORDERING INFORMATION

| $T_A$          | $V_T$ (MAX)<br>$V_{CC} = 15\text{ V}$ | PACKAGE <sup>(1)</sup> |              | ORDERABLE PART NUMBER | TOP-SIDE MARKING |
|----------------|---------------------------------------|------------------------|--------------|-----------------------|------------------|
| 0°C to 70°C    | 11.2 V                                | PDIP – N               | Tube of 25   | NE556N                | NE556N           |
|                |                                       | SOIC – D               | Tube of 50   | NE556D                | NE556            |
|                |                                       |                        | Reel of 2500 | NE556DR               |                  |
|                |                                       | SOP – NS               | Reel of 2000 | NE556NSR              | NE556            |
| –40°C to 85°C  | 11.2 V                                | PDIP – N               | Tube of 25   | SA556N                | SA556N           |
| –40°C to 105°C | 11.2 V                                | PDIP – N               | Tube of 25   | NA556N                | NA556N           |
|                |                                       | SOIC – D               | Tube of 50   | NA556D                | NA556            |
|                |                                       |                        | Reel of 2500 | NA556DR               |                  |
| –55°C to 125°C | 10.6 V                                | CDIP – J               | Tube of 25   | SE556J                | SE556J           |
|                |                                       |                        |              | SE556JB               | SE556JB          |

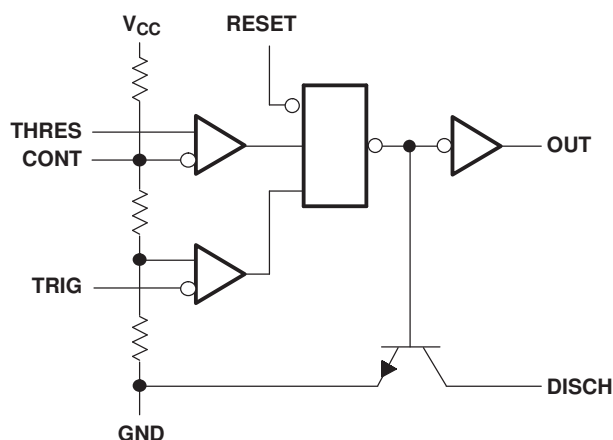
(1) Package drawings, standard packing quantities, thermal data, symbolization, and PCB design guidelines are available at [www.ti.com/sc/package](http://www.ti.com/sc/package).

### FUNCTION TABLE (each timer)

| RESET | TRIGGER VOLTAGE <sup>(1)</sup> | THRESHOLD VOLTAGE <sup>(1)</sup> | OUTPUT                    | DISCHARGE SWITCH |
|-------|--------------------------------|----------------------------------|---------------------------|------------------|
| Low   | Irrelevant                     | Irrelevant                       | Low                       | On               |
| High  | $< 1/3 V_{DD}$                 | Irrelevant                       | High                      | Off              |
| High  | $> 1/3 V_{DD}$                 | $> 2/3 V_{DD}$                   | Low                       | On               |
| High  | $> 1/3 V_{DD}$                 | $< 2/3 V_{DD}$                   | As previously established |                  |

(1) Voltage levels shown are nominal.

### FUNCTIONAL BLOCK DIAGRAM, EACH TIMER



RESET can override TRIG, which can override THRES.

## Absolute Maximum Ratings<sup>(1)</sup>

over operating free-air temperature range (unless otherwise noted)

|                  |                                                      |                              | MIN | MAX             | UNIT |
|------------------|------------------------------------------------------|------------------------------|-----|-----------------|------|
| V <sub>CC</sub>  | Supply voltage <sup>(2)</sup>                        |                              |     | 18              | V    |
| V <sub>I</sub>   | Input voltage                                        | CONT, RESET, THRES, and TRIG |     | V <sub>CC</sub> | V    |
| I <sub>O</sub>   | Output current                                       |                              |     | ±225            | mA   |
| θ <sub>JA</sub>  | Package thermal impedance <sup>(3)(4)</sup>          | D package                    |     | 86              | °C/W |
|                  |                                                      | N package                    |     | 80              |      |
|                  |                                                      | NS package                   |     | 76              |      |
| θ <sub>JC</sub>  | Package thermal impedance <sup>(5)(6)</sup>          | J package                    |     | 15.05           | °C/W |
| T <sub>J</sub>   | Operating virtual junction temperature               |                              |     | 150             | °C   |
|                  | Lead temperature 1,6 mm (1/16 in) from case for 60 s | J package                    |     | 300             | °C   |
|                  | Lead temperature 1,6 mm (1/16 in) from case for 10 s | D, N, or NS package          |     | 260             | °C   |
| T <sub>stg</sub> | Storage temperature range                            |                              | –65 | 150             | °C   |

- (1) Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.
- (2) All voltage values are with respect to network ground terminal.
- (3) Maximum power dissipation is a function of T<sub>J</sub>(max), θ<sub>JA</sub>, and T<sub>A</sub>. The maximum allowable power dissipation at any allowable ambient temperature is P<sub>D</sub> = (T<sub>J</sub>(max) – T<sub>A</sub>)/θ<sub>JA</sub>. Operating at the absolute maximum T<sub>J</sub> of 150°C can affect reliability.
- (4) The package thermal impedance is calculated in accordance with JESD 51-7.
- (5) Maximum power dissipation is a function of T<sub>J</sub>(max), θ<sub>JC</sub>, and T<sub>C</sub>. The maximum allowable power dissipation at any allowable case temperature is P<sub>D</sub> = (T<sub>J</sub>(max) – T<sub>C</sub>)/θ<sub>JC</sub>. Operating at the absolute maximum T<sub>J</sub> of 150°C can affect reliability.
- (6) The package thermal impedance is calculated in accordance with MIL-STD-883.

## Recommended Operating Conditions

|                 |                                |                              | MIN | MAX             | UNIT |
|-----------------|--------------------------------|------------------------------|-----|-----------------|------|
| V <sub>CC</sub> | Supply voltage                 | NA556, NE556, SA556          | 4.5 | 16              | V    |
|                 |                                | SE556                        | 4.5 | 18              |      |
| V <sub>I</sub>  | Input voltage                  | CONT, RESET, THRES, and TRIG |     | V <sub>CC</sub> | V    |
| I <sub>O</sub>  | Output current                 |                              |     | ±200            | mA   |
| T <sub>A</sub>  | Operating free-air temperature | NA556                        | –40 | 105             | °C   |
|                 |                                | NE556                        | 0   | 70              |      |
|                 |                                | SA556                        | –40 | 85              |      |
|                 |                                | SE556                        | –55 | 125             |      |

## Electrical Characteristics

$V_{CC} = 5\text{ V to }15\text{ V}$ ,  $T_A = 25^\circ\text{C}$  (unless otherwise noted)

| PARAMETER                                     |                                    | TEST CONDITIONS                                   |                                 | NA556<br>NE556<br>SA556 |      |      | SE556 |      |      | UNIT |
|-----------------------------------------------|------------------------------------|---------------------------------------------------|---------------------------------|-------------------------|------|------|-------|------|------|------|
|                                               |                                    |                                                   |                                 | MIN                     | TYP  | MAX  | MIN   | TYP  | MAX  |      |
| V <sub>T</sub>                                | Threshold voltage level            | V <sub>CC</sub> = 15 V                            |                                 | 8.8                     | 10   | 11.2 | 9.4   | 10   | 10.6 | V    |
|                                               |                                    | V <sub>CC</sub> = 5 V                             |                                 | 2.4                     | 3.3  | 4.2  | 2.7   | 3.3  | 4    |      |
| I <sub>T</sub>                                | Threshold current <sup>(1)</sup>   |                                                   |                                 |                         | 30   | 250  |       | 30   | 250  | nA   |
| V <sub>TRIG</sub>                             | Trigger voltage level              | V <sub>CC</sub> = 15 V                            |                                 | 4.5                     | 5    | 5.6  | 4.8   | 5    | 5.2  | V    |
|                                               |                                    |                                                   | T <sub>A</sub> = −55°C to 125°C |                         |      |      | 3     |      | 6    |      |
|                                               |                                    | V <sub>CC</sub> = 5 V                             |                                 | 1.1                     | 1.67 | 2.2  | 1.45  | 1.67 | 1.9  |      |
|                                               |                                    |                                                   | T <sub>A</sub> = −55°C to 125°C |                         |      |      |       |      | 1.9  |      |
| I <sub>TRIG</sub>                             | Trigger current                    | TRIG at 0 V                                       |                                 |                         | 0.5  | 2    |       | 0.5  | 0.9  | μA   |
| V <sub>RESET</sub>                            | Reset voltage level                |                                                   |                                 | 0.3                     | 0.7  | 1    | 0.3   | 0.7  | 1    | V    |
|                                               |                                    | T <sub>A</sub> = −55°C to 125°C                   |                                 |                         |      |      |       |      | 1.1  |      |
| I <sub>RESET</sub>                            | Reset current                      | RESET at V <sub>CC</sub>                          |                                 |                         | 0.1  | 0.4  |       | 0.1  | 0.4  | mA   |
|                                               |                                    | RESET at 0 V                                      |                                 |                         | −0.4 | 1.5  |       | −0.4 | −1   |      |
| I <sub>DISCH</sub>                            | Discharge switch off-state current |                                                   |                                 |                         | 20   | 100  |       | 20   | 100  | nA   |
| V <sub>CONT</sub>                             | Control voltage (open circuit)     | V <sub>CC</sub> = 15 V                            |                                 | 9                       | 10   | 11   | 9.6   | 10   | 10.4 | V    |
|                                               |                                    |                                                   | T <sub>A</sub> = −55°C to 125°C |                         |      |      | 9.6   |      | 10.4 |      |
|                                               |                                    | V <sub>CC</sub> = 5 V                             |                                 | 2.6                     | 3.3  | 4    | 2.9   | 3.3  | 3.8  |      |
|                                               |                                    |                                                   | T <sub>A</sub> = −55°C to 125°C |                         |      |      | 2.9   |      | 3.8  |      |
| V <sub>OL</sub>                               | Low-level output voltage           | V <sub>CC</sub> = 15 V, I <sub>OL</sub> = 10 mA   |                                 |                         | 0.1  | 0.25 |       | 0.1  | 0.15 | V    |
|                                               |                                    |                                                   | T <sub>A</sub> = −55°C to 125°C |                         |      |      |       |      | 0.2  |      |
|                                               |                                    | V <sub>CC</sub> = 15 V, I <sub>OL</sub> = 50 mA   |                                 |                         | 0.4  | 0.75 |       | 0.4  | 0.5  |      |
|                                               |                                    |                                                   | T <sub>A</sub> = −55°C to 125°C |                         |      |      |       |      | 1    |      |
|                                               |                                    | V <sub>CC</sub> = 15 V, I <sub>OL</sub> = 100 mA  |                                 |                         | 2    | 2.5  |       | 2    | 2.2  |      |
|                                               |                                    |                                                   | T <sub>A</sub> = −55°C to 125°C |                         |      |      |       |      | 2.7  |      |
|                                               |                                    | V <sub>CC</sub> = 15 V, I <sub>OL</sub> = 200 mA  |                                 |                         |      | 2.5  |       | 2.5  |      |      |
|                                               |                                    | V <sub>CC</sub> = 5 V, I <sub>OL</sub> = 3.5 mA   | T <sub>A</sub> = −55°C to 125°C |                         |      |      |       |      | 0.35 |      |
|                                               |                                    | V <sub>CC</sub> = 5 V, I <sub>OL</sub> = 5 mA     |                                 |                         | 0.1  | 0.25 |       | 0.1  | 0.15 |      |
| T <sub>A</sub> = −55°C to 125°C               |                                    |                                                   |                                 |                         |      |      | 0.8   |      |      |      |
| V <sub>CC</sub> = 5 V, I <sub>OL</sub> = 8 mA |                                    |                                                   |                                 | 0.15                    | 0.3  |      | 0.15  | 0.25 |      |      |
| V <sub>OH</sub>                               | High-level output voltage          | V <sub>CC</sub> = 15 V, I <sub>OH</sub> = −100 mA |                                 | 12.75                   | 13.3 |      | 13    | 13.3 | V    |      |
|                                               |                                    |                                                   | T <sub>A</sub> = −55°C to 125°C |                         |      |      | 12    |      |      |      |
|                                               |                                    | V <sub>CC</sub> = 15 V, I <sub>OH</sub> = −200 mA |                                 |                         |      | 12.5 |       | 12.5 |      |      |
|                                               |                                    | V <sub>CC</sub> = 5 V, I <sub>OH</sub> = −100 mA  |                                 | 2.75                    | 3.3  |      | 3     | 3.3  |      |      |
|                                               |                                    |                                                   | T <sub>A</sub> = −55°C to 125°C |                         |      |      | 2     |      |      |      |
| I <sub>CC</sub>                               | Supply current                     | Output low, No load                               | V <sub>CC</sub> = 15 V          |                         | 20   | 30   |       | 20   | 24   | mA   |
|                                               |                                    |                                                   | V <sub>CC</sub> = 5 V           |                         | 6    | 12   |       | 6    | 10   |      |
|                                               |                                    | Output high, No load                              | V <sub>CC</sub> = 15 V          |                         | 18   | 26   |       | 18   | 20   |      |
|                                               |                                    |                                                   | V <sub>CC</sub> = 5 V           |                         | 4    | 10   |       | 4    | 8    |      |

(1) This parameter influences the maximum value of the timing resistors  $R$  and  $R_B$  in the circuit of [Figure 1](#). For example, when  $V_{CC} = 5\text{ V}$ , the maximum value is  $R = R_A + R_B \approx 3.4\text{ M}\Omega$ , and for  $V_{CC} = 15\text{ V}$ , the maximum value is  $\approx 10\text{ M}\Omega$ .

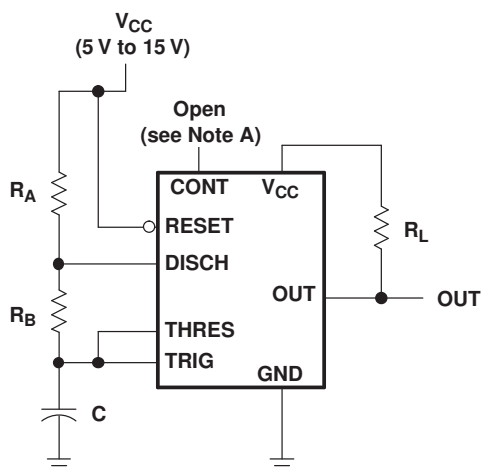
## Operating Characteristics

$V_{CC} = 5\text{ V}$  and  $15\text{ V}$

| PARAMETER                                       |                                       | TEST CONDITIONS <sup>(1)</sup>                     | NA556<br>NE556<br>SA556 |           |     | SE556 |           |                    | UNIT                  |
|-------------------------------------------------|---------------------------------------|----------------------------------------------------|-------------------------|-----------|-----|-------|-----------|--------------------|-----------------------|
|                                                 |                                       |                                                    | MIN                     | TYP       | MAX | MIN   | TYP       | MAX                |                       |
| Initial error of timing interval <sup>(2)</sup> | Each timer, monostable <sup>(3)</sup> | $T_A = 25^\circ\text{C}$                           |                         | 1         | 3   |       | 0.5       | 1.5 <sup>(4)</sup> |                       |
|                                                 | Each timer, astable <sup>(5)</sup>    |                                                    |                         | 2.25%     |     |       | 1.5%      |                    |                       |
|                                                 | Timer 1 – Timer 2                     |                                                    |                         | $\pm 1$   |     |       | $\pm 0.5$ |                    |                       |
| Temperature coefficient of timing interval      | Each timer, monostable <sup>(3)</sup> | $T_A = \text{MIN to MAX}$                          |                         | 50        |     |       | 30        | 100 <sup>(4)</sup> | ppm/ $^\circ\text{C}$ |
|                                                 | Each timer, astable <sup>(5)</sup>    |                                                    |                         | 150       |     |       | 90        |                    |                       |
|                                                 | Timer 1 – Timer 2                     |                                                    |                         | $\pm 10$  |     |       | $\pm 10$  |                    |                       |
| Supply voltage sensitivity of timing interval   | Each timer, monostable <sup>(3)</sup> | $T_A = 25^\circ\text{C}$                           |                         | 0.1       | 0.5 |       | 0.05      | 0.2 <sup>(4)</sup> | %/V                   |
|                                                 | Each timer, astable <sup>(5)</sup>    |                                                    |                         | 0.3       |     |       | 0.15      |                    |                       |
|                                                 | Timer 1 – Timer 2                     |                                                    |                         | $\pm 0.2$ |     |       | $\pm 0.1$ |                    |                       |
| Output-pulse rise time                          |                                       | $C_L = 15\text{ pF}$ ,<br>$T_A = 25^\circ\text{C}$ |                         | 100       | 300 |       | 100       | 200 <sup>(4)</sup> | ns                    |
| Output-pulse fall time                          |                                       | $C_L = 15\text{ pF}$ ,<br>$T_A = 25^\circ\text{C}$ |                         | 100       | 300 |       | 100       | 200 <sup>(4)</sup> | ns                    |

- (1) For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.
- (2) Timing-interval error is defined as the difference between the measured value and the average value of a random sample from each process run.
- (3) Values specified are for a device in a monostable circuit similar to [Figure 2](#), with the following component values:  $R_A = 2\text{ k}\Omega$  to  $100\text{ k}\Omega$ ,  $C = 0.1\text{ }\mu\text{F}$ .
- (4) On products compliant to MIL-PRF-38535, this parameter is not production tested.
- (5) Values specified are for a device in an astable circuit similar to [Figure 1](#), with the following component values:  $R_A = 1\text{ k}\Omega$  to  $100\text{ k}\Omega$ ,  $C = 0.1\text{ }\mu\text{F}$ .

## APPLICATION INFORMATION



NOTE A: Bypassing the control-voltage input to ground with a capacitor might improve operation. This should be evaluated for individual applications.

Figure 1. Circuit for Astable Operation

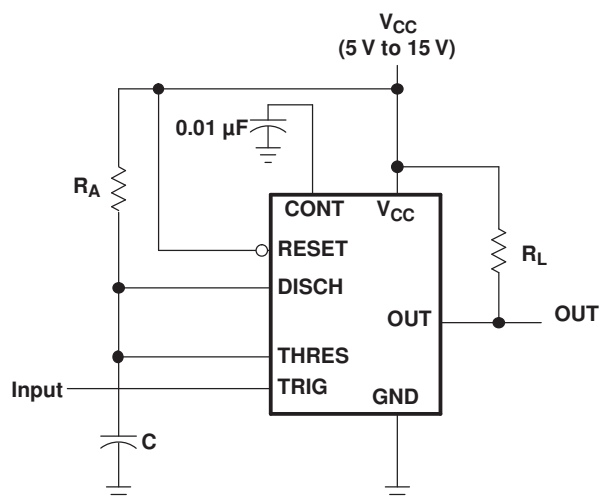


Figure 2. Circuit for Monostable Operation

**PACKAGING INFORMATION**

| Orderable Device | Status<br>(1) | Package Type | Package<br>Drawing | Pins | Package<br>Qty | Eco Plan<br>(2)            | Lead/Ball Finish<br>(6) | MSL Peak Temp<br>(3) | Op Temp (°C) | Device Marking<br>(4/5) | Samples                 |
|------------------|---------------|--------------|--------------------|------|----------------|----------------------------|-------------------------|----------------------|--------------|-------------------------|-------------------------|
| JM38510/10902BCA | ACTIVE        | CDIP         | J                  | 14   | 1              | TBD                        | A42                     | N / A for Pkg Type   | -55 to 125   | JM38510<br>/10902BCA    | <a href="#">Samples</a> |
| M38510/10902BCA  | ACTIVE        | CDIP         | J                  | 14   | 1              | TBD                        | A42                     | N / A for Pkg Type   | -55 to 125   | JM38510<br>/10902BCA    | <a href="#">Samples</a> |
| NA556D           | ACTIVE        | SOIC         | D                  | 14   | 50             | Green (RoHS<br>& no Sb/Br) | CU NIPDAU               | Level-1-260C-UNLIM   | -40 to 105   | NA556                   | <a href="#">Samples</a> |
| NA556DG4         | ACTIVE        | SOIC         | D                  | 14   | 50             | Green (RoHS<br>& no Sb/Br) | CU NIPDAU               | Level-1-260C-UNLIM   | -40 to 105   | NA556                   | <a href="#">Samples</a> |
| NA556DR          | ACTIVE        | SOIC         | D                  | 14   | 2500           | Green (RoHS<br>& no Sb/Br) | CU NIPDAU               | Level-1-260C-UNLIM   | -40 to 105   | NA556                   | <a href="#">Samples</a> |
| NA556DRG4        | ACTIVE        | SOIC         | D                  | 14   | 2500           | Green (RoHS<br>& no Sb/Br) | CU NIPDAU               | Level-1-260C-UNLIM   | -40 to 105   | NA556                   | <a href="#">Samples</a> |
| NA556N           | ACTIVE        | PDIP         | N                  | 14   | 25             | Pb-Free<br>(RoHS)          | CU NIPDAU               | N / A for Pkg Type   | -40 to 105   | NA556N                  | <a href="#">Samples</a> |
| NE556D           | ACTIVE        | SOIC         | D                  | 14   | 50             | Green (RoHS<br>& no Sb/Br) | CU NIPDAU               | Level-1-260C-UNLIM   | 0 to 70      | NE556                   | <a href="#">Samples</a> |
| NE556DBR         | ACTIVE        | SSOP         | DB                 | 14   | 2000           | Green (RoHS<br>& no Sb/Br) | CU NIPDAU               | Level-1-260C-UNLIM   | 0 to 70      | N556                    | <a href="#">Samples</a> |
| NE556DR          | ACTIVE        | SOIC         | D                  | 14   | 2500           | Green (RoHS<br>& no Sb/Br) | CU NIPDAU               | Level-1-260C-UNLIM   | 0 to 70      | NE556                   | <a href="#">Samples</a> |
| NE556DRE4        | ACTIVE        | SOIC         | D                  | 14   | 2500           | Green (RoHS<br>& no Sb/Br) | CU NIPDAU               | Level-1-260C-UNLIM   | 0 to 70      | NE556                   | <a href="#">Samples</a> |
| NE556DRG4        | ACTIVE        | SOIC         | D                  | 14   | 2500           | Green (RoHS<br>& no Sb/Br) | CU NIPDAU               | Level-1-260C-UNLIM   | 0 to 70      | NE556                   | <a href="#">Samples</a> |
| NE556N           | ACTIVE        | PDIP         | N                  | 14   | 25             | Pb-Free<br>(RoHS)          | CU NIPDAU               | N / A for Pkg Type   | 0 to 70      | NE556N                  | <a href="#">Samples</a> |
| NE556NE4         | ACTIVE        | PDIP         | N                  | 14   | 25             | Pb-Free<br>(RoHS)          | CU NIPDAU               | N / A for Pkg Type   | 0 to 70      | NE556N                  | <a href="#">Samples</a> |
| NE556NSR         | ACTIVE        | SO           | NS                 | 14   | 2000           | Green (RoHS<br>& no Sb/Br) | CU NIPDAU               | Level-1-260C-UNLIM   | 0 to 70      | NE556                   | <a href="#">Samples</a> |
| SA556D           | OBSOLETE      | SOIC         | D                  | 14   |                | TBD                        | Call TI                 | Call TI              | -40 to 85    |                         |                         |
| SA556DR          | OBSOLETE      | SOIC         | D                  | 14   |                | TBD                        | Call TI                 | Call TI              | -40 to 85    |                         |                         |
| SA556N           | ACTIVE        | PDIP         | N                  | 14   | 25             | Pb-Free<br>(RoHS)          | CU NIPDAU               | N / A for Pkg Type   | -40 to 85    | SA556N                  | <a href="#">Samples</a> |

| Orderable Device | Status<br>(1) | Package Type | Package Drawing | Pins | Package Qty | Eco Plan<br>(2) | Lead/Ball Finish<br>(6) | MSL Peak Temp<br>(3) | Op Temp (°C) | Device Marking<br>(4/5) | Samples                 |
|------------------|---------------|--------------|-----------------|------|-------------|-----------------|-------------------------|----------------------|--------------|-------------------------|-------------------------|
| SA556NE4         | ACTIVE        | PDIP         | N               | 14   | 25          | Pb-Free (RoHS)  | CU NIPDAU               | N / A for Pkg Type   | -40 to 85    | SA556N                  | <a href="#">Samples</a> |
| SE556FKB         | OBSOLETE      | LCCC         | FK              | 20   |             | TBD             | Call TI                 | Call TI              | -55 to 125   |                         |                         |
| SE556J           | ACTIVE        | CDIP         | J               | 14   | 1           | TBD             | A42                     | N / A for Pkg Type   | -55 to 125   | SE556J                  | <a href="#">Samples</a> |
| SE556JB          | ACTIVE        | CDIP         | J               | 14   | 1           | TBD             | A42                     | N / A for Pkg Type   | -55 to 125   | SE556JB                 | <a href="#">Samples</a> |

(1) The marketing status values are defined as follows:

**ACTIVE:** Product device recommended for new designs.

**LIFEBUY:** TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

**NRND:** Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

**PREVIEW:** Device has been announced but is not in production. Samples may or may not be available.

**OBSOLETE:** TI has discontinued the production of the device.

(2) Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check <http://www.ti.com/productcontent> for the latest availability information and additional product content details.

**TBD:** The Pb-Free/Green conversion plan has not been defined.

**Pb-Free (RoHS):** TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

**Pb-Free (RoHS Exempt):** This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

**Green (RoHS & no Sb/Br):** TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

(3) MSL, Peak Temp. - The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

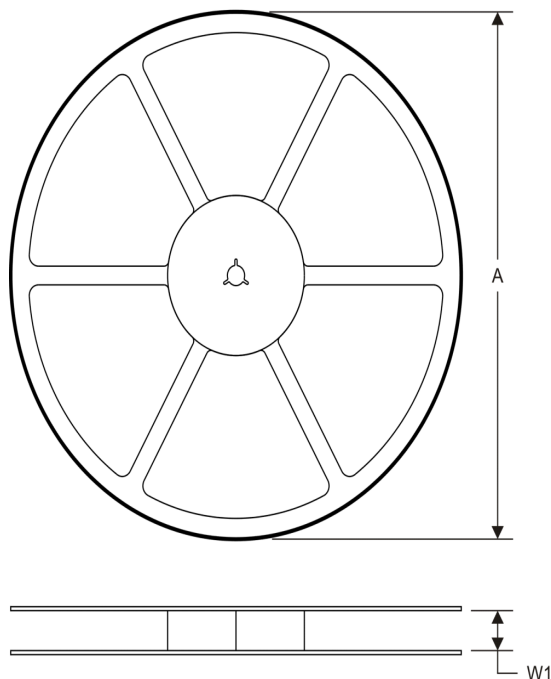
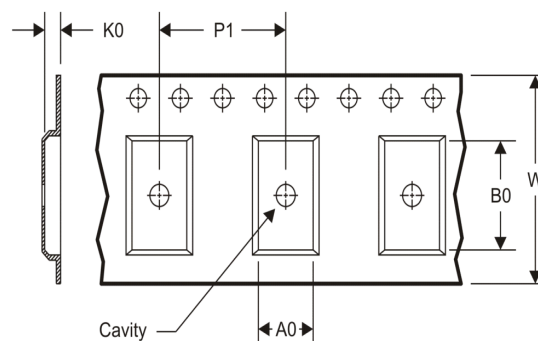
(4) There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.

(5) Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.

(6) Lead/Ball Finish - Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead/Ball Finish values may wrap to two lines if the finish value exceeds the maximum column width.

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**TAPE AND REEL INFORMATION**
**REEL DIMENSIONS**

**TAPE DIMENSIONS**


|    |                                                           |
|----|-----------------------------------------------------------|
| A0 | Dimension designed to accommodate the component width     |
| B0 | Dimension designed to accommodate the component length    |
| K0 | Dimension designed to accommodate the component thickness |
| W  | Overall width of the carrier tape                         |
| P1 | Pitch between successive cavity centers                   |

**TAPE AND REEL INFORMATION**

\*All dimensions are nominal

| Device   | Package Type | Package Drawing | Pins | SPQ  | Reel Diameter (mm) | Reel Width W1 (mm) | A0 (mm) | B0 (mm) | K0 (mm) | P1 (mm) | W (mm) | Pin1 Quadrant |
|----------|--------------|-----------------|------|------|--------------------|--------------------|---------|---------|---------|---------|--------|---------------|
| NA556DR  | SOIC         | D               | 14   | 2500 | 330.0              | 16.4               | 6.5     | 9.0     | 2.1     | 8.0     | 16.0   | Q1            |
| NE556DBR | SSOP         | DB              | 14   | 2000 | 330.0              | 16.4               | 8.2     | 6.6     | 2.5     | 12.0    | 16.0   | Q1            |
| NE556DR  | SOIC         | D               | 14   | 2500 | 330.0              | 16.4               | 6.5     | 9.0     | 2.1     | 8.0     | 16.0   | Q1            |
| NE556NSR | SO           | NS              | 14   | 2000 | 330.0              | 16.4               | 8.2     | 10.5    | 2.5     | 12.0    | 16.0   | Q1            |

## TAPE AND REEL BOX DIMENSIONS



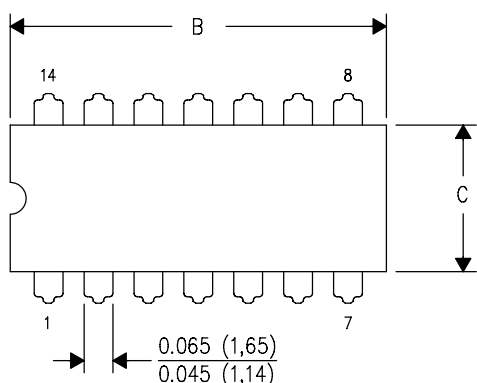
\*All dimensions are nominal

| Device   | Package Type | Package Drawing | Pins | SPQ  | Length (mm) | Width (mm) | Height (mm) |
|----------|--------------|-----------------|------|------|-------------|------------|-------------|
| NA556DR  | SOIC         | D               | 14   | 2500 | 367.0       | 367.0      | 38.0        |
| NE556DBR | SSOP         | DB              | 14   | 2000 | 367.0       | 367.0      | 38.0        |
| NE556DR  | SOIC         | D               | 14   | 2500 | 367.0       | 367.0      | 38.0        |
| NE556NSR | SO           | NS              | 14   | 2000 | 367.0       | 367.0      | 38.0        |

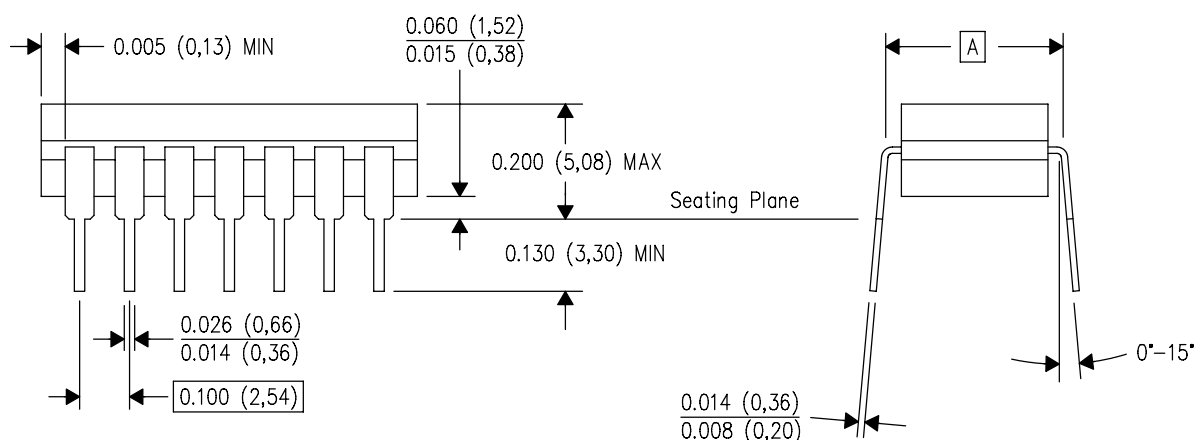
J (R-GDIP-T\*\*)

14 LEADS SHOWN

# CERAMIC DUAL IN-LINE PACKAGE



| PINS **<br>DIM | 14                     | 16                     | 18                     | 20                     |
|----------------|------------------------|------------------------|------------------------|------------------------|
| A              | 0.300<br>(7,62)<br>BSC | 0.300<br>(7,62)<br>BSC | 0.300<br>(7,62)<br>BSC | 0.300<br>(7,62)<br>BSC |
| B MAX          | 0.785<br>(19,94)       | .840<br>(21,34)        | 0.960<br>(24,38)       | 1.060<br>(26,92)       |
| B MIN          | —                      | —                      | —                      | —                      |
| C MAX          | 0.300<br>(7,62)        | 0.300<br>(7,62)        | 0.310<br>(7,87)        | 0.300<br>(7,62)        |
| C MIN          | 0.245<br>(6,22)        | 0.245<br>(6,22)        | 0.220<br>(5,59)        | 0.245<br>(6,22)        |



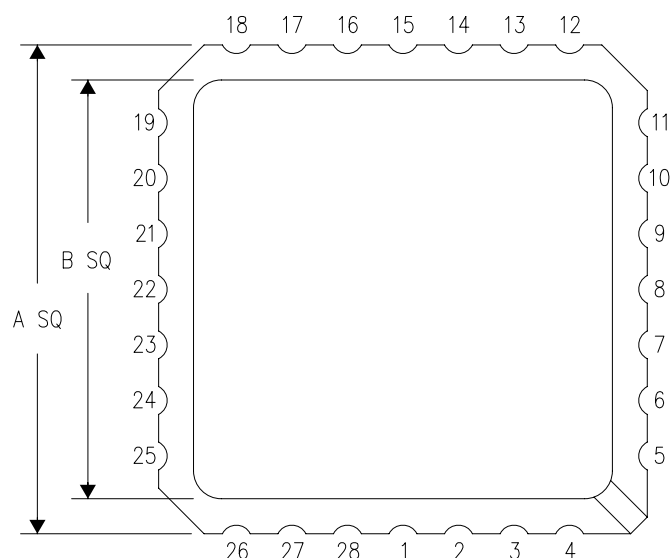
4040083/F 03/03

- NOTES:
- A. All linear dimensions are in inches (millimeters).
  - B. This drawing is subject to change without notice.
  - C. This package is hermetically sealed with a ceramic lid using glass frit.
  - D. Index point is provided on cap for terminal identification only on press ceramic glass frit seal only.
  - E. Falls within MIL STD 1835 GDIP1-T14, GDIP1-T16, GDIP1-T18 and GDIP1-T20.

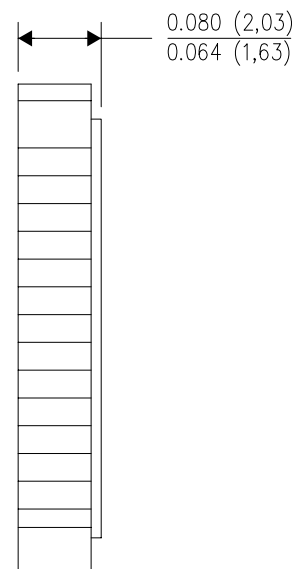
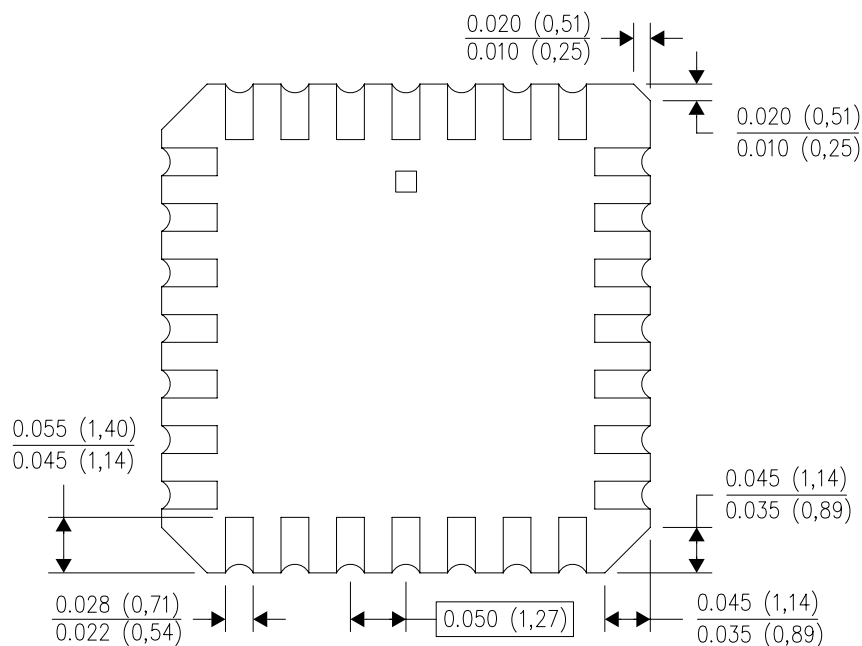
FK (S-CQCC-N\*\*)

LEADLESS CERAMIC CHIP CARRIER

28 TERMINAL SHOWN



| NO. OF<br>TERMINALS<br>** | A                |                  | B                |                  |
|---------------------------|------------------|------------------|------------------|------------------|
|                           | MIN              | MAX              | MIN              | MAX              |
| 20                        | 0.342<br>(8,69)  | 0.358<br>(9,09)  | 0.307<br>(7,80)  | 0.358<br>(9,09)  |
| 28                        | 0.442<br>(11,23) | 0.458<br>(11,63) | 0.406<br>(10,31) | 0.458<br>(11,63) |
| 44                        | 0.640<br>(16,26) | 0.660<br>(16,76) | 0.495<br>(12,58) | 0.560<br>(14,22) |
| 52                        | 0.740<br>(18,78) | 0.761<br>(19,32) | 0.495<br>(12,58) | 0.560<br>(14,22) |
| 68                        | 0.938<br>(23,83) | 0.962<br>(24,43) | 0.850<br>(21,6)  | 0.858<br>(21,8)  |
| 84                        | 1.141<br>(28,99) | 1.165<br>(29,59) | 1.047<br>(26,6)  | 1.063<br>(27,0)  |



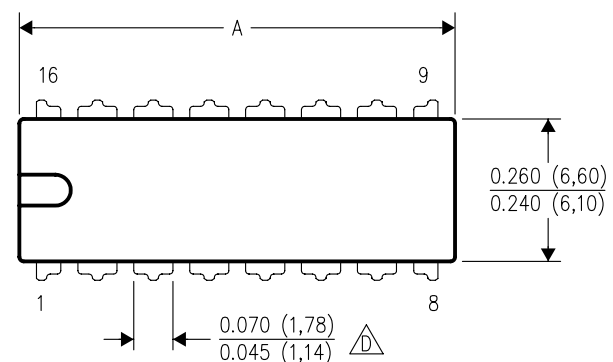
4040140/D 01/11

- NOTES:
- All linear dimensions are in inches (millimeters).
  - This drawing is subject to change without notice.
  - This package can be hermetically sealed with a metal lid.
  - Falls within JEDEC MS-004

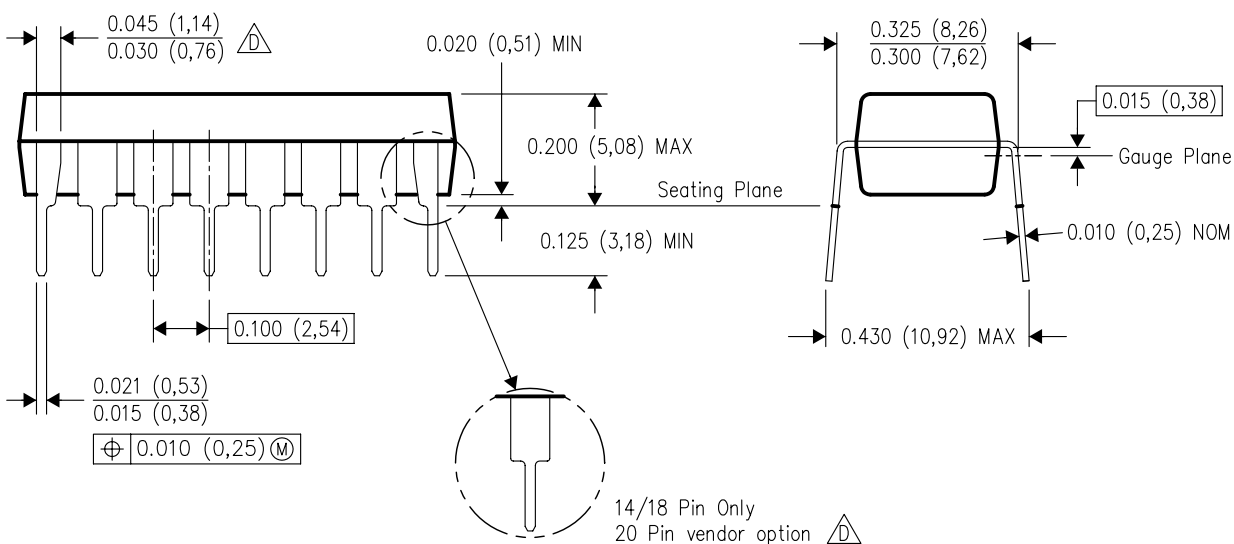
## N (R-PDIP-T\*\*)

16 PINS SHOWN

## PLASTIC DUAL-IN-LINE PACKAGE



| PINS **             | 14               | 16               | 18               | 20               |
|---------------------|------------------|------------------|------------------|------------------|
| DIM                 |                  |                  |                  |                  |
| A MAX               | 0.775<br>(19,69) | 0.775<br>(19,69) | 0.920<br>(23,37) | 1.060<br>(26,92) |
| A MIN               | 0.745<br>(18,92) | 0.745<br>(18,92) | 0.850<br>(21,59) | 0.940<br>(23,88) |
| MS-001<br>VARIATION | AA               | BB               | AC               | AD               |

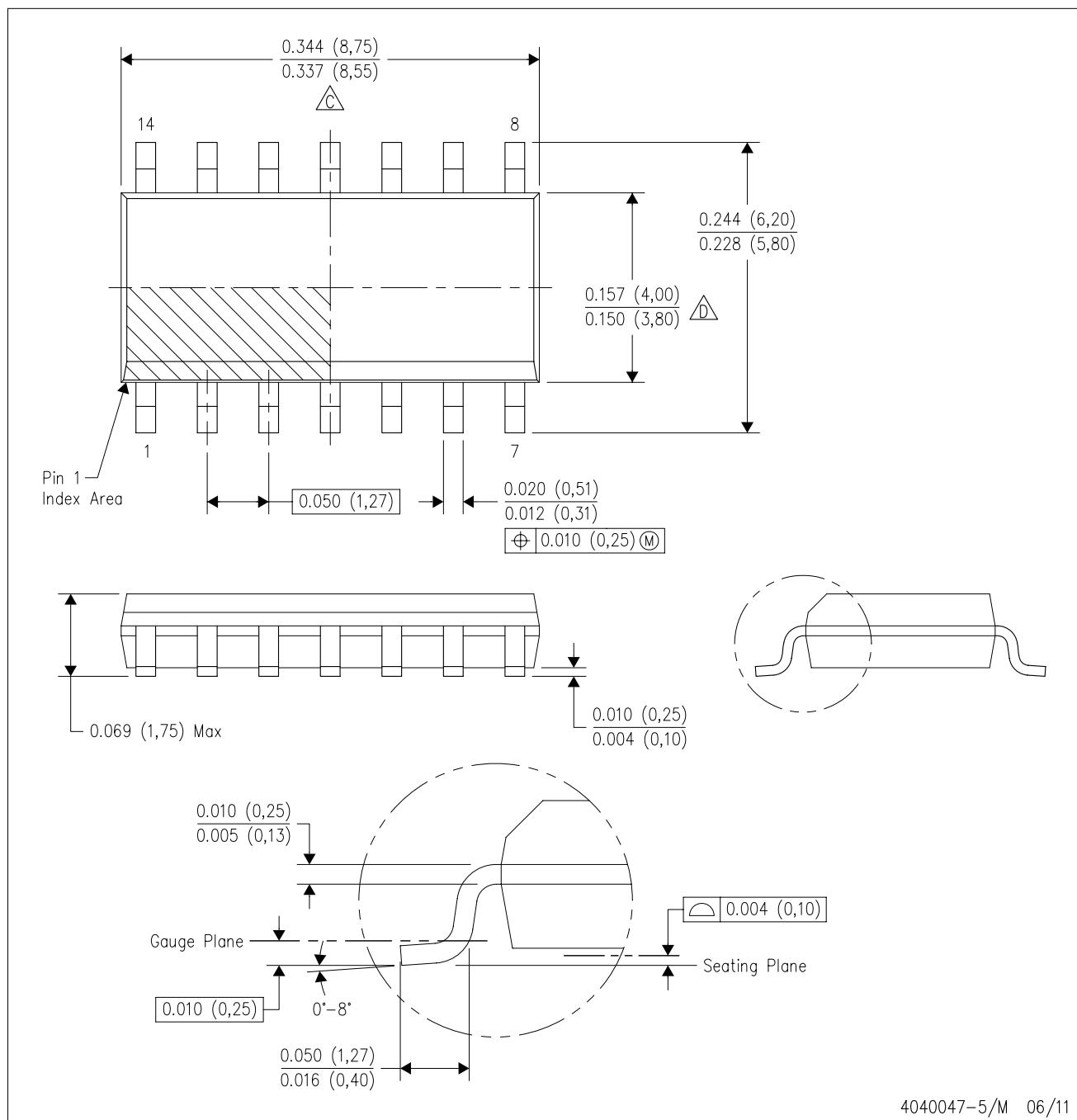


4040049/E 12/2002

- NOTES:
- A. All linear dimensions are in inches (millimeters).
  - B. This drawing is subject to change without notice.
  - C. Falls within JEDEC MS-001, except 18 and 20 pin minimum body length (Dim A).
  - D. The 20 pin end lead shoulder width is a vendor option, either half or full width.

D (R-PDSO-G14)

PLASTIC SMALL OUTLINE



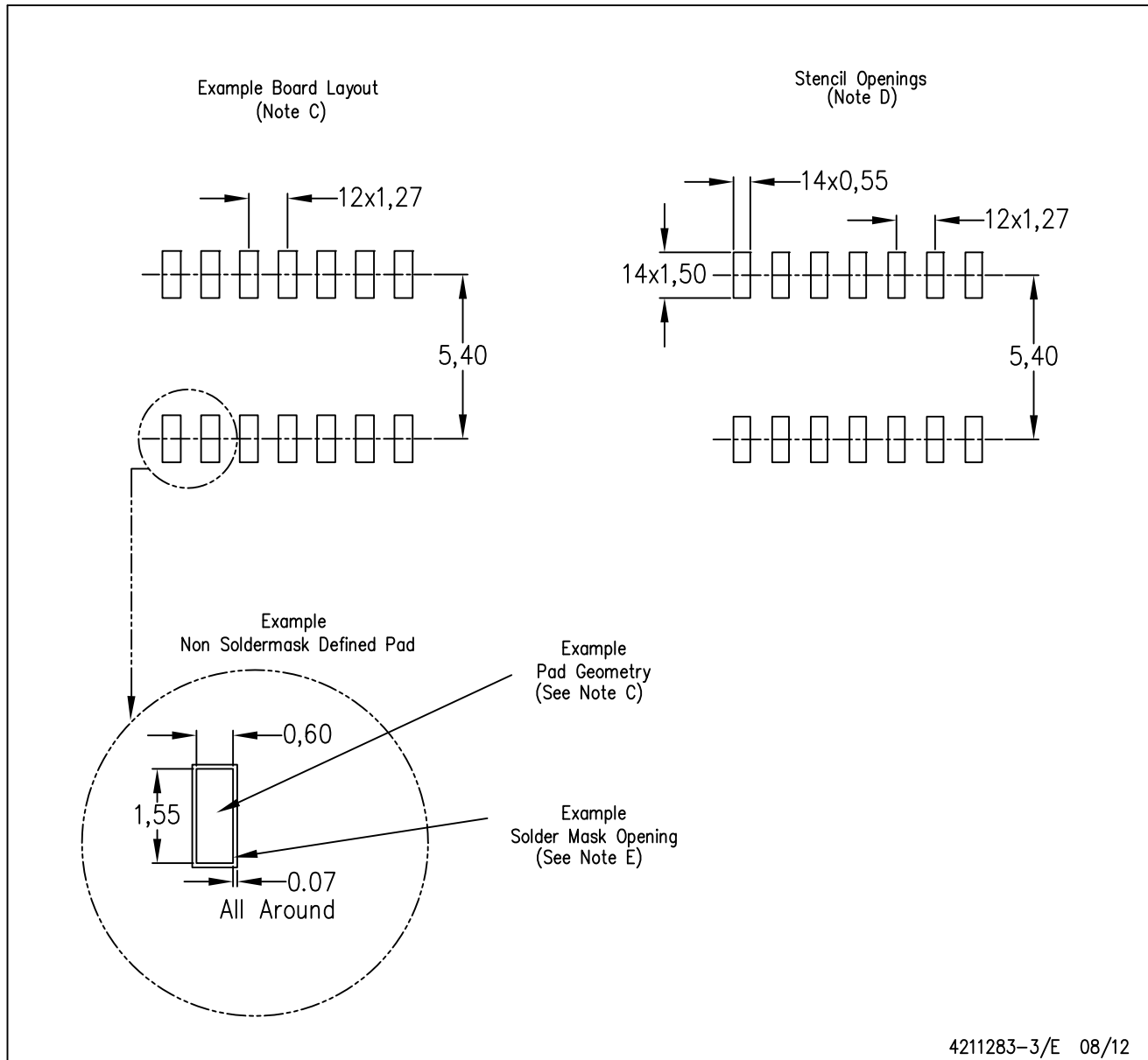
4040047-5/M 06/11

NOTES:

- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- C. Body length does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.006 (0,15) each side.
- D. Body width does not include interlead flash. Interlead flash shall not exceed 0.017 (0,43) each side.
- E. Reference JEDEC MS-012 variation AB.

D (R-PDSO-G14)

PLASTIC SMALL OUTLINE



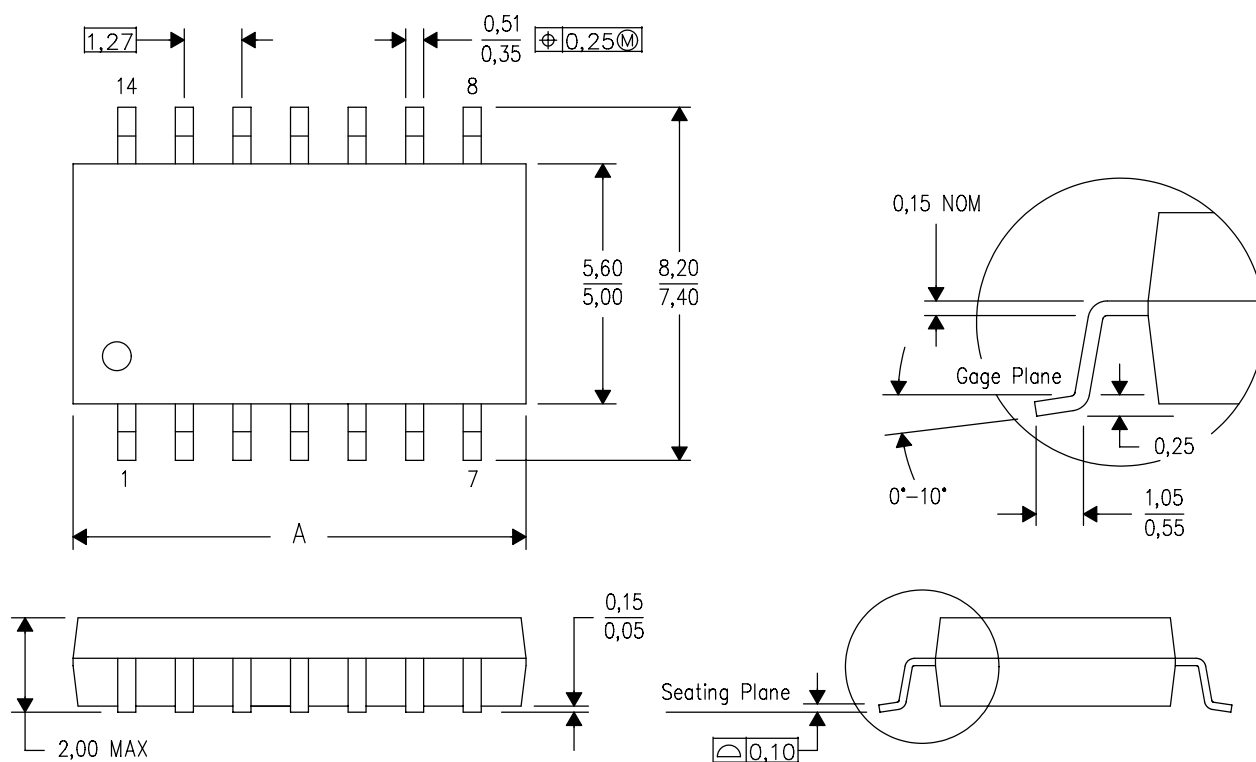
- NOTES:
- A. All linear dimensions are in millimeters.
  - B. This drawing is subject to change without notice.
  - C. Publication IPC-7351 is recommended for alternate designs.
  - D. Laser cutting apertures with trapezoidal walls and also rounding corners will offer better paste release. Customers should contact their board assembly site for stencil design recommendations. Refer to IPC-7525 for other stencil recommendations.
  - E. Customers should contact their board fabrication site for solder mask tolerances between and around signal pads.

# MECHANICAL DATA

NS (R-PDSO-G\*\*)

PLASTIC SMALL-OUTLINE PACKAGE

14-PINS SHOWN



| DIM \ PINS ** | 14    | 16    | 20    | 24    |
|---------------|-------|-------|-------|-------|
| A MAX         | 10,50 | 10,50 | 12,90 | 15,30 |
| A MIN         | 9,90  | 9,90  | 12,30 | 14,70 |

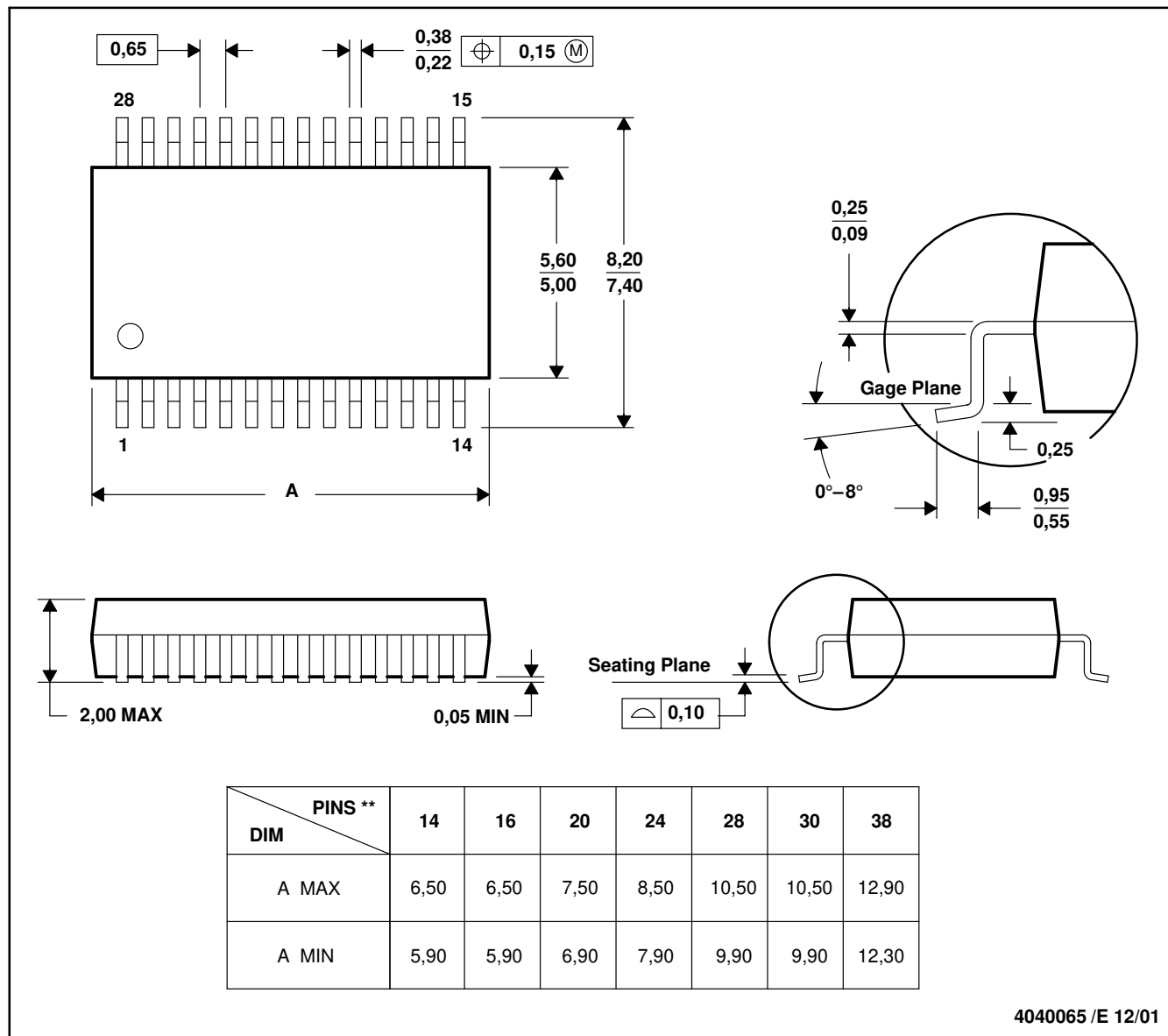
4040062/C 03/03

- NOTES:
- A. All linear dimensions are in millimeters.
  - B. This drawing is subject to change without notice.
  - C. Body dimensions do not include mold flash or protrusion, not to exceed 0,15.

## DB (R-PDSO-G\*\*)

## PLASTIC SMALL-OUTLINE

28 PINS SHOWN



- NOTES: A. All linear dimensions are in millimeters.  
 B. This drawing is subject to change without notice.  
 C. Body dimensions do not include mold flash or protrusion not to exceed 0,15.  
 D. Falls within JEDEC MO-150

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